

## C1825C393MDRACTU

Aliases (C1825C393MDRAC7800) SMD Comm X7R HV, Ceramic, 0.039 uF, 20%, 1,000 VDC, X7R, SMD, MLCC, High Voltage, Temperature Stable, 1825, 2.3 mm



General Information	
Series	SMD Comm X7R HV
Style	SMD Chip
Description	SMD, MLCC, High Voltage, Temperature Stable
Features	High Voltage
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	280 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	1825
L	4.5mm +/-0.3mm
W	6.4mm +/-0.4mm
Т	1.6mm +/-0.20mm
S	2.3mm MIN
В	0.6mm +/-0.35mm
	0.011111 / 0.0011111

1000

Packaging Quantity

VV	0.411111 +/ -0.411111	Tolerance
Т	1.6mm +/-0.20mm	Voltage DC
S	2.3mm MIN	Dielectric Withstar
В	0.6mm +/-0.35mm	Temperature Rang
		Temp. Coefficient
Packaging Specifications		Capacitance Chan
Packaging	T&R, 180mm, Plastic Tape	Reference to +25°0

Specifications	
Capacitance	0.039 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	20%
Voltage DC	1000 VDC
Dielectric Withstanding Voltage	1,200 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5%1kHz1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	25.641 GOhms

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